

AMENDMENTS TO THE SPECIFICATION

Please DELETE the section headings at page 4, lines 11 and 12.

Please replace the section heading at page 5, line 12 with the following rewritten section heading:

~~-- MEANS TO SOLVE PROBLEMS~~SUMMARY OF THE INVENTION --

Please DELETE the section heading at page 9, line 7.

Please replace the paragraph at page 10, line 5 with the following rewritten paragraphs:

Fig. 1 is a schematic sectional view of a typical substrate for device bonding of the present invention-; and

Please DELETE the text beginning at page 10, line 10 through page 11, line 3 in its entirety.

Please replace the section heading at page 11, line 5 with the following rewritten section heading:

~~-- BEST MODE FOR CARRYING OUT~~DETAILED DESCRIPTION OF
THE INVENTION --